

# 20V N-Channel Trench MOSFET

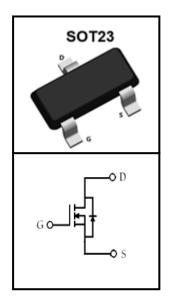
#### **FEATURES**

- Super Low Gate Charge
- RoHS compliant
- Green Device Available
- Excellent CdV/dt effect decline
- Advanced high cell density Trench technology

#### **APPLICATIONS**

- Load switch
- Battery protection
- Power management





Device Markin	g and Package I	nformation
Device	Package	Marking
CTZ2302A	SOT23	2302A

Absolute Maximum Ratings at T <sub>j</sub> = 25°C unless otherwise noted					
Parameter		Symbol	Value	Unit	
Drain-Source Voltage (V <sub>GS</sub> = 0V)		$V_{DSS}$	20	V	
Continuous Drain Current T <sub>A</sub> = 25°C	(note1)	I <sub>D</sub>	2.5	А	
Pulsed Drain Current	(note2)	I <sub>DM</sub>	10	А	
Gate Source Voltage		$V_{GSS}$	±12	V	
Power Dissipation	(note3)	$P_D$	1	W	
Operating Junction and Storage Temperature	Range	$T_J, T_{stg}$	-55~150	°C	

Thermal Characteristics				
Parameter		Symbol	Value	Unit
Thermal Resistance, Junction-Ambient	(note1)	$R_{\theta JA}$	125	°C/W



Electrical Characteristics T	- 23 O ui	r				
Parameter	Symbol	Test Conditions	Value			Unit
i arameter	Oyiliboi	rest conditions	Min.	Тур.	Max.	Jill
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_{D} = 250\mu A$	20	-		<b>V</b>
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 20V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	uA
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 12V$			±100	nA
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.5	0.65	1.0	V
Drain-Source On-Resistance (note2)	D	$V_{GS} = 4.5V, I_D = 2.5A$		46	60	mΩ
	R <sub>DS(on)</sub>	$V_{GS} = 2.5V, I_D = 1A$		61	85	mΩ
Dynamic						
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0V$ ,		180		
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 10V$ ,		38		pF
Reverse Transfer Capacitance	$C_{rss}$	f = 1.0MHz		20		
Total Gate Charge (4.5V)	$Q_g$			3.5		
Gate-Source Charge	$Q_{gs}$	$V_{DD} = 10V, I_{D} = 2.5A,$ $V_{GS} = 4.5V$		0.6		nC
Gate-Drain Charge	$Q_gd$			0.45		
Turn-on Delay Time	t <sub>d(on)</sub>			8		
Turn-on Rise Time	t <sub>r</sub>	$V_{DS} = 10V, I_{D} = 2.5A$ $V_{GS} = 4.5V, R_{G} = 2.5\Omega, RL = 15\Omega$		7		nS
Turn-off Delay Time	t <sub>d(off)</sub>			30		
Turn-off Fall Time	t <sub>f</sub>			7		
Body Diode Characteristics						
Continuous Body Diode Current	I <sub>S</sub>				2.5	•
Pulsed Diode Forward Current	I <sub>SM</sub>				10	Α
Body Diode Voltage	V <sub>SD</sub>	$T_J = 25^{\circ}\text{C}, I_{SD} = 2.5\text{A}, V_{GS} = 0\text{V}$		0.75	1.2	V

#### Notes

- 1. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.
- 2. The data tested by pulsed , pulse width≤300us , duty cycle≤2%
- 3. The power dissipation is limited by 150°C junction temperature
- 4. The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.



# **Typical Characteristics** $T_J = 25$ °C, unless otherwise noted

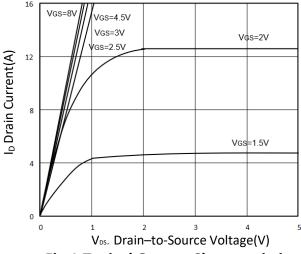


Fig.1 Typical Output Characteristics

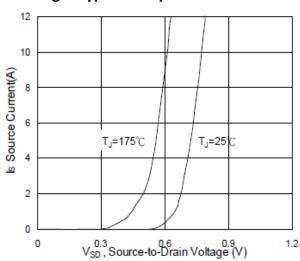


Fig.3 Forward Characteristics of Reverse Diode

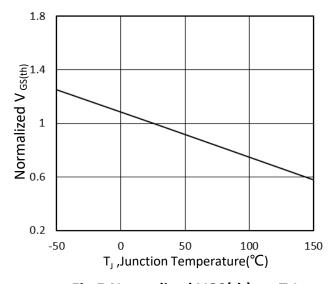


Fig.5 Normalized VGS(th) vs. T J

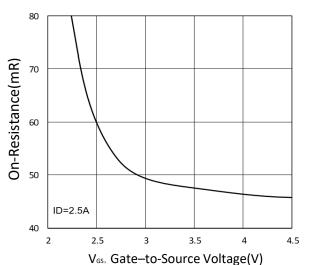


Fig. 2 On-Resistance vs. G-S Voltage

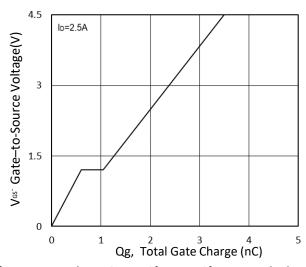


Fig.4 Gate-Charge Characteristics

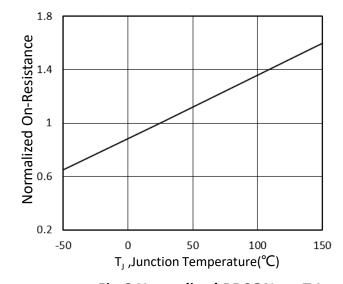


Fig.6 Normalized RDSON vs. T J



# **Typical Characteristics** $T_J = 25^{\circ}\text{C}$ , unless otherwise noted

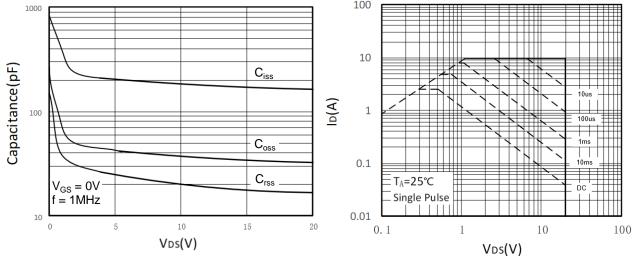


Fig.7 Capacitance

Fig.8 Safe Operating Area

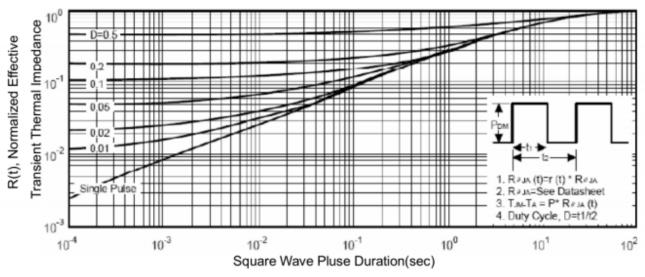


Fig.9 Normalized Maximum Transient Thermal Impedance



Figure A: Gate Charge Test Circuit and Waveform

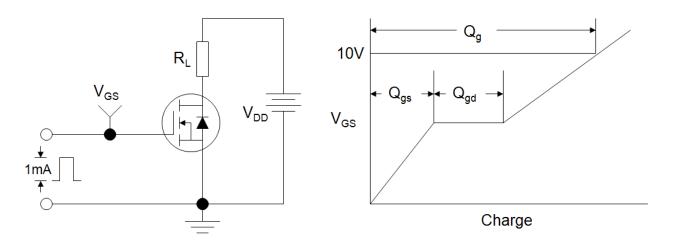


Figure B: Resistive Switching Test Circuit and Waveform

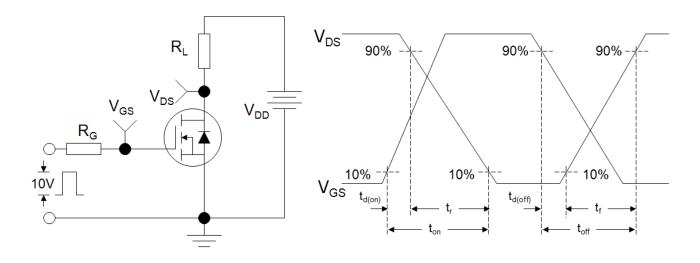
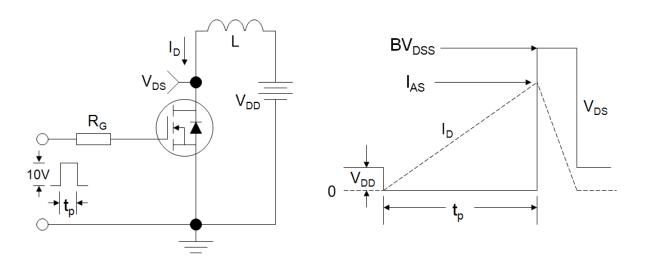
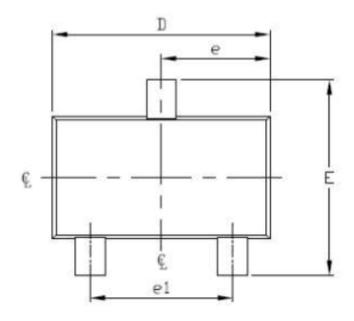


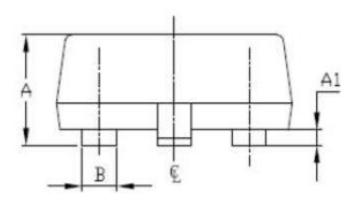
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

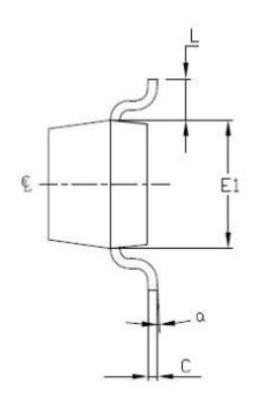




# SOT23







SYMBOL -	mm				
	MIN	NOM	MAX		
Α	0. 9	1.0	1. 1		
A1	0.00	0.06	0. 1		
В	0. 3	0.4	0. 5		
С	0. 07	0.09	0. 18		
D	2. 8	2. 9	3. 04		
E	2. 1	2. 33	2. 64		
E1	1. 2	1.3	1.4		
е	1. 4	1. 45	1.5		
e1	1. 80	1.90	2. 00		
L	0. 45	0. 54	0. 63		
α	0°	2. 5°	7°		



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